

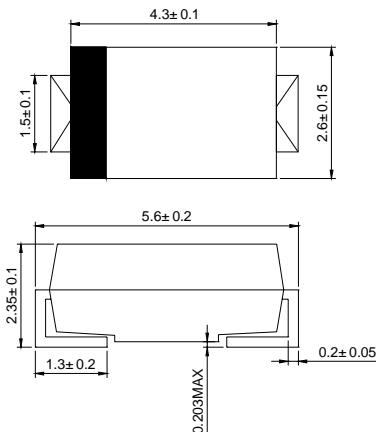


REVERSE VOLTAGE: 50 --- 1000 V
CURRENT: 1.0 A

Features

- ◇ Plastic package has underwriters laborator flammability classification 94V-0
- ◇ For surface mounted applications
- ◇ Low profile package
- ◇ Built-in strain relief,ideal for automated placement
- ◇ High temperature soldering:
250 °C/10 seconds at terminals

SMAJ



Dimensions in millimeters

Mechanical Data

- ◇ Case:JEDEC SMAJ,molded plastic
- ◇ Polarity: color band denotes cathode end
- ◇ Weight: 0.003 ounces, 0.084 grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

		FS1AJ	FS1BJ	FS1DJ	FS1GJ	FS1JJ	FS1KJ	FS1MJ	UNITS				
Device marking		RS1A	RS1B	RS1D	RS1G	RS1J	RS1K	RS1M					
Maximum recurrent peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V				
Maximum RMS voltage	V_{RWS}	35	70	140	280	420	560	700	V				
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V				
Maximum average forward rectified current @ $T_L=90^\circ\text{C}$	$I_{F(AV)}$	1.0						A					
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load	I_{FSM}	30.0						A					
Maximum instantaneous forward voltage at 1.0A	V_F	1.30						V					
Maximum DC reverse current @ $T_A=25^\circ\text{C}$ at rated DC blocking voltage @ $T_A=125^\circ\text{C}$	I_R	5.0 50.0						μA					
Maximum reverse recovery time (NOTE 1)	t_{rr}	150		250		500		ns					
Typical junction capacitance (NOTE 2)	C_J	10		7.0		pF							
Typical thermal resistance (NOTE 3)	$R_{\theta JA}$ $R_{\theta JL}$	105 32						$^\circ\text{C}/\text{W}$					
Operating junction and storage temperature range	$T_J T_{STG}$	- 55 ----- + 150						$^\circ\text{C}$					

NOTE: 1.Reverse recovery time test conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{rr}=0.25\text{A}$

2. Measured at 1.0MHz and applied reverse voltage of 4.0 Volts

3. Thermal resistance from junction to ambient and junction to lead P.C.B.mounted on 0.2"X0.2"(5.0X5.0mm²) copper pad areas

Ratings AND Characteristic Curves

Fig. 1 — Forward Current Derating Curve

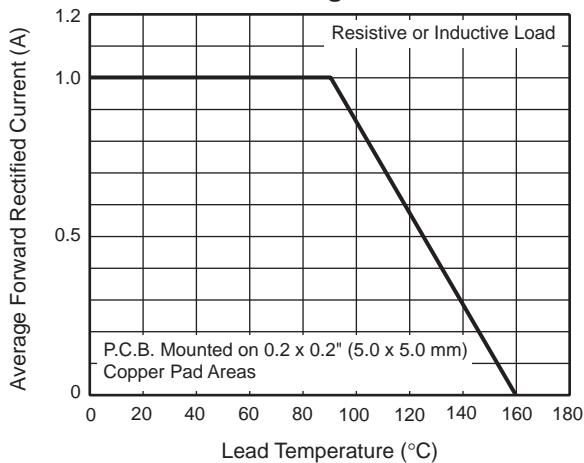


Fig. 3 — Typical Instantaneous Forward Characteristics

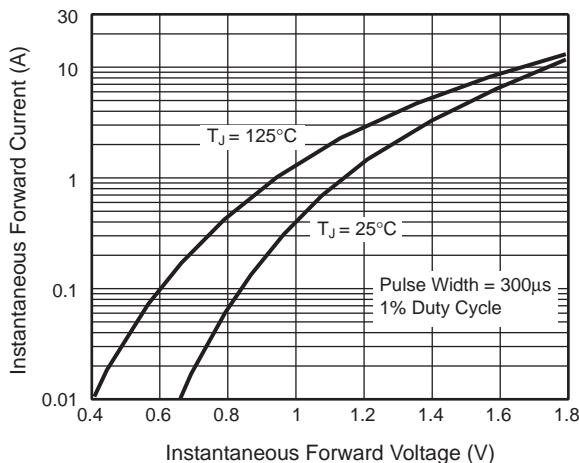


Fig. 5 — Typical Junction Capacitance

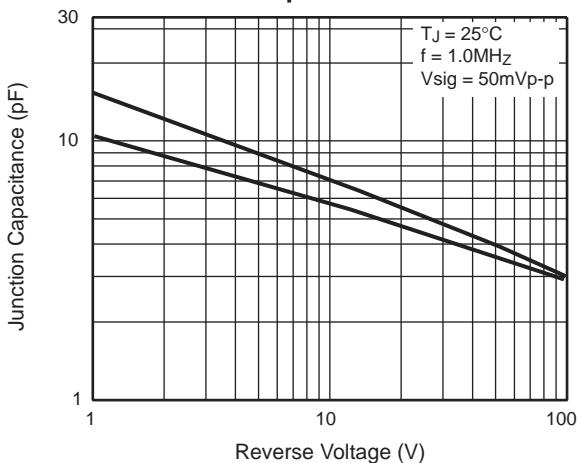


Fig. 2 — Maximum Non-Repetitive Peak Forward Surge Current

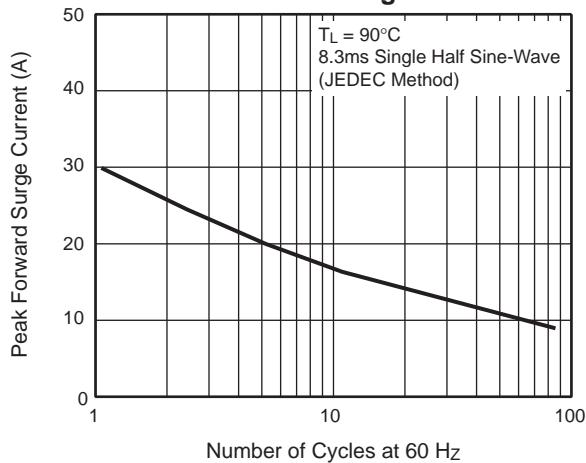


Fig. 4 — Typical Reverse Characteristics

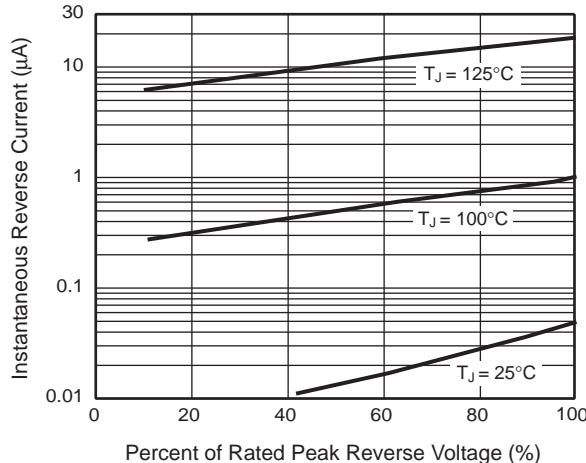


Fig. 6 — Typical Transient Thermal Impedance

